



Capabilities

Our on-site manufacturing facility features the industry's most advanced equipment to provide quality results that can be delivered again and again.

Quantity	No minimums. Low to Mid-Volume & Prototypes - Even Just 1
Turn Time	1 Day, 3 Day, 5 Day, 10 Day
Type of Assembly	SMT, Thru-Hole Double-sided SMT Turn-Key, Partial or Full Consignment
Solder Type	Water Soluable Solder Paste Leaded and Lead-Free (RoHS)
Components	Passives down to 01005 Fine Pitch to 08 Mils BGA & VFBGA BGA Repair and Reball* Leadless chip carriers/CSP Press-Fit Connectors Part Removal & Replacement
Bare Board Size	Smallest: .25 x .25 inches Largest: 20 x 24 inches Single or Panelized Unique Board Outlines
Component Packaging	Continuous Tape Cut Tape Tube Reels Loose Parts
Testing	Up to Class III Inspection 3D X-Ray Inspection Flying Probe AOI Inspection



*Only available on Advanced Assembly jobs.

ISO 9001:2008 Certified | ITAR Registered | IPC Member Facility

**What you're saying is that your project is behind schedule,
but you still need 25 PCBs assembled in five days? **Sure.****
(There's a cheetah in our logo for a reason.)

